









ProLight PP6N-1LFE-P
1W RGB Power LED
Technical Datasheet
Version: 2.3

# **ProLight Opto PP6N Series**

#### **Features**

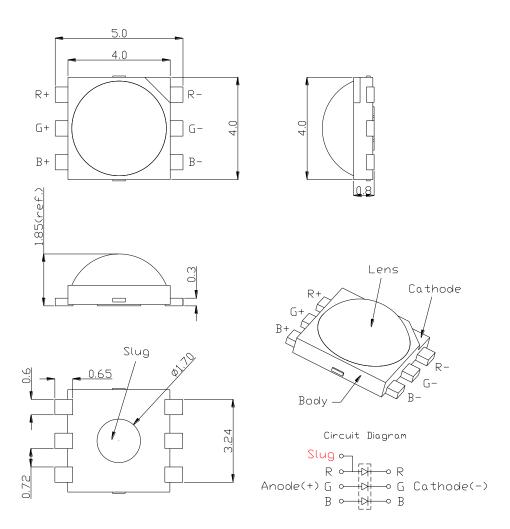
- · R, G, B three color in one Package
- · Good color uniformity
- · Best moisture sensitivity level JEDEC Level 1
- · Lead free reflow soldering
- · RoHS compliant
- More energy efficient than incandescent and most halogen lamps
- · Low Voltage DC operated
- · Instant light (less than 100ns)
- · No UV

#### **Main Applications**

- · Reading lights (car, bus, aircraft)
- · Portable (flashlight, bicycle)
- · Uplighters/Downlighters
- · Decorative/Entertainment
- · Bollards/Security/Garden
- · Cove/Undershelf/Task
- · Indoor/Outdoor Commercial and Residential Architectural
- · Automotive Ext (Stop-Tail-Turn, CHMSL, Mirror Side Repeat)
- · LCD backlights



#### **Emitter Mechanical Dimensions**



#### Notes:

- 1. The cathode side of the device is denoted by the chamfer on the part body.
- 2. Electrical insulation between the case and the board is required. Do not electrically connect either the anode or cathode to the slug.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. Unless otherwise indicated, tolerances are  $\pm$  0.10mm.
- 6. Please do not bend the leads of the LED, otherwise it will damage the LED.
- 7. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

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<sup>\*</sup>The appearance and specifications of the product may be modified for improvement without notice.



## Flux Characteristics at 150mA, $T_1 = 25$ °C

| Radiation  | Color | Part Number | Luminous Flux $\Phi_{v}$ (lm) |         |
|------------|-------|-------------|-------------------------------|---------|
| Pattern    | Coloi | Emitter     | Minimum                       | Typical |
|            | Red   |             | 23                            | 28      |
| Lambertian | Green | PP6N-1LFE-P | 38                            | 45      |
|            | Blue  |             | 8                             | 9.5     |

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

## Optical Characteristics at 150mA, T<sub>J</sub> = 25°C

| Radiation  | Color | Domi   | nant Wavelen | gth $\lambda_{ m D}$ | Total<br>included<br>Angle<br>(degrees) | Viewing<br>Angle<br>(degrees) |
|------------|-------|--------|--------------|----------------------|---|-------------------------------|
| Pattern    | COIOI | Min.   | Тур.         | Max.                 | $\theta_{0.90V}$                        | 2 θ <sub>1/2</sub>            |
|            | Red   | 620 nm | 623 nm       | 630 nm               | 160                                     | 140                           |
| Lambertian | Green | 525 nm | 530 nm       | 535 nm               | 160                                     | 140                           |
|            | Blue  | 455 nm | 458 nm       | 460 nm               | 160                                     | 140                           |

ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

## Electrical Characteristics at 150mA, T<sub>1</sub> = 25°C

| Color | Fo   | rward Voltage V <sub>F</sub> | (V)  |
|-------|------|------------------------------|------|
| Coloi | Min. | Тур.                         | Max. |
| Red   | 1.90 | 2.15                         | 2.50 |
| Green | 2.60 | 2.85                         | 3.20 |
| Blue  | 2.80 | 3.05                         | 3.40 |

 $<sup>\</sup>bullet$  ProLight maintains a tolerance of  $\pm$  0.1V for Voltage measurements.

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## **Absolute Maximum Ratings**

| Parameter   | Red/Green/Blue                            |  |
|---|---|--|
| DC Forward Current (mA)                                       | 200                                       |  |
| Peak Pulsed Forward Current (mA)                              | 250 (less than 1/10 duty cycle@1KHz)      |  |
| ESD Sensitivity   | > ±500V                                   |  |
| (HBM per MIL-STD-883E Method 3015.7) LED Junction Temperature | 120°C                                     |  |
| Operating Board Temperature at Maximum DC Forward Current     | -40°C - 105°C                             |  |
| Storage Temperature   | -40°C - 120°C                             |  |
| Soldering Temperature   | JEDEC 020c 260°C                          |  |
| Allowable Reflow Cycles                                       | 3   |  |
| Reverse Voltage   | Not designed to be driven in reverse bias |  |

#### **Photometric Luminous Flux Bin Structure**

| Color | Bin Code | Minimum<br>Photometric Flux (Im) | Maximum Photometric Flux (Im) |
|-------|----------|----------------------------------|-------------------------------|
| Red   | 0        | 23                               | 36                            |
| Green | 0        | 38                               | 58                            |
| Blue  | 0        | 8                                | 12                            |

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.



#### **Dominant Wavelength Bin Structure**

| Color | Bin Code | Minimum Dominant<br>Wavelength (nm) | Maximum Dominant<br>Wavelength (nm) |
|-------|----------|-------------------------------------|-------------------------------------|
| Red   | 4        | 620                                 | 630                                 |
| Green | 2        | 525                                 | 535                                 |
| Blue  | А        | 455                                 | 460                                 |

<sup>•</sup> ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

#### **Forward Voltage Bin Structure**

| Color | Bin Code | Minimum Voltage (V) | Maximum Voltage (V) |
|-------|----------|---------------------|---------------------|
| Red   | A        | 1.9                 | 2.2                 |
|       | B        | 2.2                 | 2.5                 |
| Green | A        | 2.6                 | 2.9                 |
|       | B        | 2.9                 | 3.2                 |
| Blue  | A        | 2.8                 | 3.1                 |
|       | B        | 3.1                 | 3.4                 |

ullet ProLight maintains a tolerance of  $\pm$  0.1V for Voltage measurements.

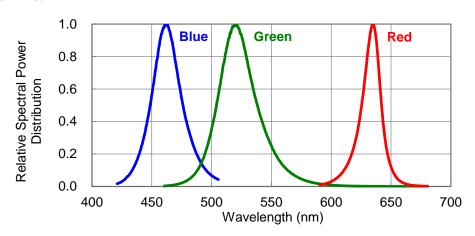
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

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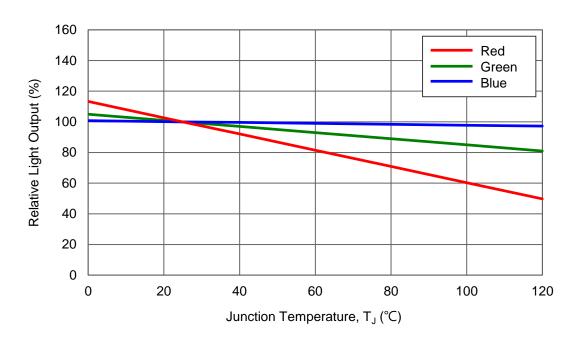
## Color Spectrum, $T_1 = 25^{\circ}C$

1. Blue \ Green \ Red



## **Light Output Characteristics**

Relative Light Output vs. Junction Temperature at 150mA

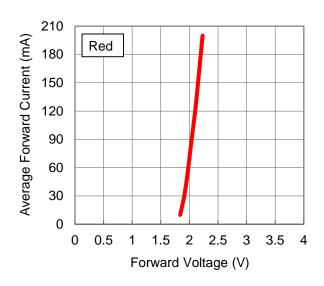


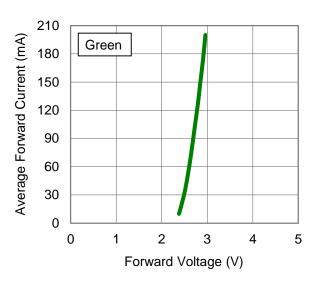
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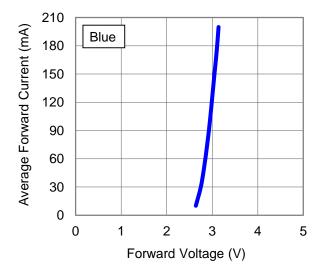


## Forward Current Characteristics, T<sub>j</sub> = 25°C

1. Forward Voltage vs. Forward Current





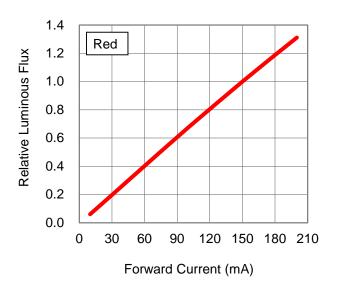


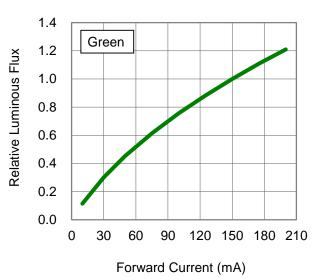
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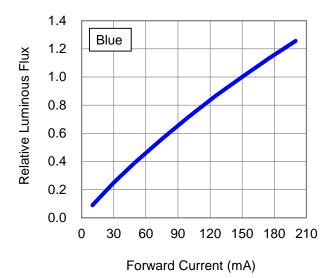


## Forward Current Characteristics, T<sub>J</sub> = 25°C

2. Forward Current vs. Normalized Relative Luminous Flux



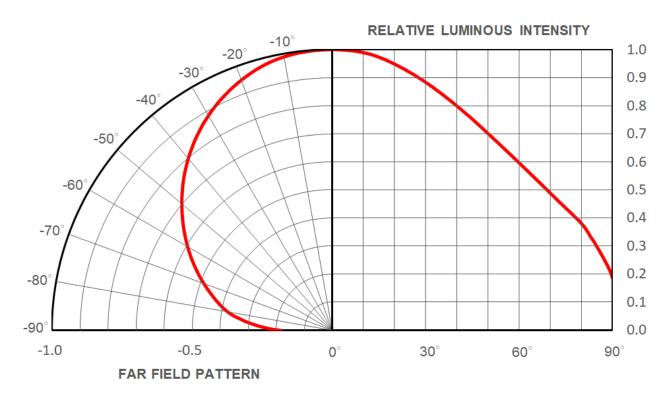




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## **Typical Representative Spatial Radiation Pattern**





### **Moisture Sensitivity Level - JEDEC Level 1**

|       |           |                   | Soak Requirements |                  |              |             |
|-------|-----------|-------------------|-------------------|------------------|--------------|-------------|
| Level | Floo      | r Life            | Stan              | dard             | Accelerated  | Environment |
|       | Time      | Conditions        | Time (hours)      | Conditions       | Time (hours) | Conditions  |
| 1     | Unlimited | ≤30°C /<br>85% RH | 168 +5/-0         | 85°C /<br>85% RH | NA           | NA          |

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

|       |                        |                   |                        | Soak Req         | uirements    |                         |  |
|-------|------------------------|-------------------|------------------------|------------------|--------------|-------------------------|--|
| Level | Floor                  | r Life            | Stan                   | dard             | Accelerated  | Accelerated Environment |  |
|       | Time                   | Conditions        | Time (hours)           | Conditions       | Time (hours) | Conditions              |  |
| 1     | Unlimited              | ≤30°C /<br>85% RH | 168 +5/-0              | 85°C /<br>85% RH | NA           | NA                      |  |
| 2     | 1 year                 | ≤30°C /<br>60% RH | 168 +5/-0              | 85°C /<br>60% RH | NA           | NA                      |  |
| 2a    | 4 weeks                | ≤30°C /<br>60% RH | 696 +5/-0              | 30°C /<br>60% RH | 120 +1/-0    | 60°C /<br>60% RH        |  |
| 3     | 168 hours              | ≤30°C /<br>60% RH | 192 +5/-0              | 30°C /<br>60% RH | 40 +1/-0     | 60°C /<br>60% RH        |  |
| 4     | 72 hours               | ≤30°C /<br>60% RH | 96 +2/-0               | 30°C /<br>60% RH | 20 +0.5/-0   | 60°C /<br>60% RH        |  |
| 5     | 48 hours               | ≤30°C /<br>60% RH | 72 +2/-0               | 30°C /<br>60% RH | 15 +0.5/-0   | 60°C /<br>60% RH        |  |
| 5a    | 24 hours               | ≤30°C /<br>60% RH | 48 +2/-0               | 30°C /<br>60% RH | 10 +0.5/-0   | 60°C /<br>60% RH        |  |
| 6     | Time on Label<br>(TOL) | ≤30°C /<br>60% RH | Time on Label<br>(TOL) | 30°C /<br>60% RH | NA           | NA                      |  |



### **Qualification Reliability Testing**

| Stress Test                                    | Stress Conditions  | Stress<br>Duration | Failure Criteria        |
|--|--|--------------------|-------------------------|
| Room Temperature Operating Life (RTOL)         | 25°C, I <sub>F</sub> = max DC (Note 1)   | 1000 hours         | Note 2                  |
| Wet High Temperature<br>Operating Life (WHTOL) | 85°C/60%RH, I <sub>F</sub> = max DC (Note 1)                                   | 1000 hours         | Note 2                  |
| Wet High Temperature<br>Storage Life (WHTSL)   | 85°C/85%RH, non-operating  | 1000 hours         | Note 2                  |
| High Temperature<br>Storage Life (HTSL)        | 110°C, non-operating   | 1000 hours         | Note 2                  |
| Low Temperature<br>Storage Life (LTSL)         | -40°C, non-operating   | 1000 hours         | Note 2                  |
| Non-operating Temperature Cycle (TMCL)         | -40°C to 120°C, 30 min. dwell,<br><5 min. transfer                             | 200 cycles         | Note 2                  |
| Mechanical Shock                               | 1500 G, 0.5 msec. pulse,<br>5 shocks each 6 axis                               |                    | Note 3                  |
| Natural Drop                                   | On concrete from 1.2 m, 3X   |                    | Note 3                  |
| Variable Vibration<br>Frequency                | 10-2000-10 Hz, log or linear sweep rate,<br>20 G about 1 min., 1.5 mm, 3X/axis |                    | Note 3                  |
| Solder Heat Resistance<br>(SHR)                | 260°C ± 5°C, 10 sec.   |                    | Note 3                  |
| Solderability                                  | Steam age for 16 hrs., then solder dip at 260°C for 5 sec.                     |                    | Solder coverage on lead |

#### Notes:

- 1. Depending on the maximum derating curve.
- 2. Criteria for judging failure

| Item  | Test Condition          | Criteria for Judgement |                     |  |
|---|-------------------------|------------------------|---------------------|--|
| item  | Test Condition          | Min.                   | Max.                |  |
| Forward Voltage (V <sub>F</sub> )             | $I_F = max DC$          |                        | Initial Level x 1.1 |  |
| Luminous Flux or Radiometric Power $(\Phi_V)$ | I <sub>F</sub> = max DC | Initial Level x 0.7    |                     |  |
| Reverse Current (I <sub>R</sub> )             | $V_R = 5V$              |                        | 50 µA               |  |

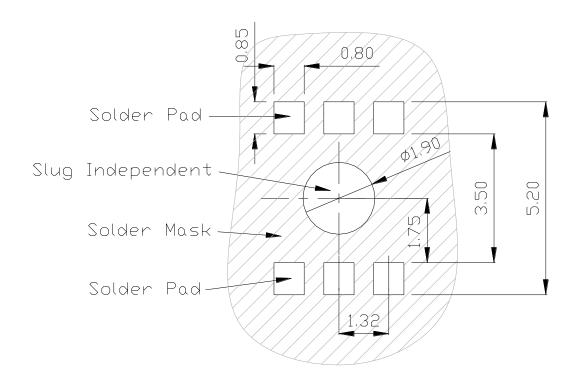
<sup>\*</sup> The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

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## **Recommended Solder Pad Design**



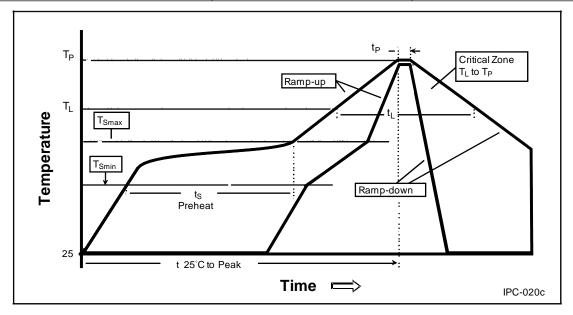
- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

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### **Reflow Soldering Condition**

| Profile Feature                                   | Sn-Pb Eutectic Assembly | Pb-Free Assembly  |
|---|-------------------------|-------------------|
| Average Ramp-Up Rate                              | 3°C / second max.       | 3°C / second max. |
| $(T_{Smax} \text{ to } T_{p})$                    | 5 C/ Second Max.        | 3 C/ second max.  |
| Preheat   |                         |                   |
| – Temperature Min (T <sub>Smin</sub> )            | 100°C                   | 150°C             |
| – Temperature Max (T <sub>Smax</sub> )            | 150°C                   | 200°C             |
| – Time (t <sub>Smin</sub> to t <sub>Smax</sub> )  | 60-120 seconds          | 60-180 seconds    |
| Time maintained above:                            |                         |                   |
| – Temperature (T <sub>L</sub> )                   | 183°C                   | 217°C             |
| – Time (t <sub>L</sub> )                          | 60-150 seconds          | 60-150 seconds    |
| Peak/Classification Temperature (T <sub>P</sub> ) | 240°C                   | 260°C             |
| Time Within 5°C of Actual Peak                    | 10-30 seconds           | 20-40 seconds     |
| Temperature (t <sub>p</sub> )                     | TO-30 Seconds           | 20-40 seconds     |
| Ramp-Down Rate                                    | 6°C/second max.         | 6°C/second max.   |
| Time 25°C to Peak Temperature                     | 6 minutes max.          | 8 minutes max.    |

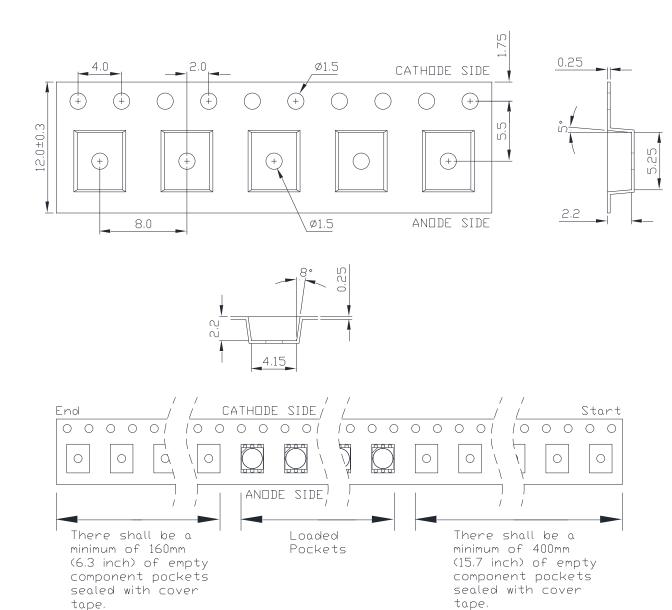


- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
  double-head soldering iron should be used. It should be confirmed beforehand whether the
  characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

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### **Emitter Reel Packaging**



#### Notes:

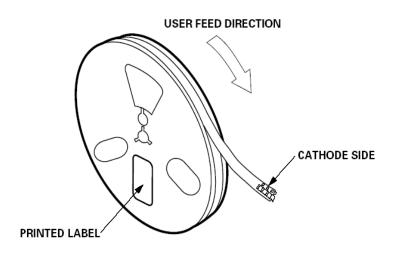
- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm\,0.10\text{mm}$ .

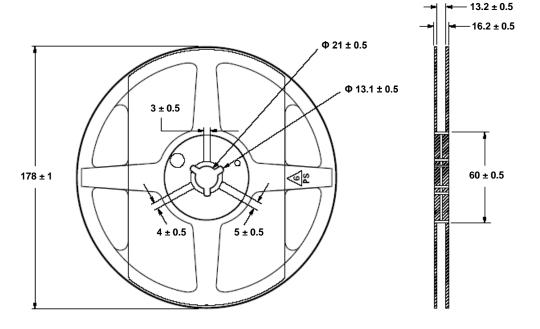
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## **Emitter Reel Packaging**





#### Notes

- 1. Empty component pockets sealed with top cover tape.
- 2. 1,000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.

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#### **Precaution for Use**

- Storage
  - Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.
- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- The LEDs are sensitive to electrostatic discharge. Appropriate ESD protection measures
  must be taken when working with the LEDs. Non-compliance with ESD protection measures
  may lead to damage or destruction of the LEDs.
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Electric Static Discharge (ESD) Protection
   The LEDs are STATIC SENSITIVE device. ESD protection or surge voltages shall be considered and taken care in the initial design stage, and whole production process.
   The following protection is recommended:
  - (1) A wrist band or an anti-electrostatic glove shall be used when handling the LEDs.
  - (2) All devices, equipment and machinery must be properly grounded.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/



#### **Handling of Silicone LEDs**

Notes for handling of silicone lens LEDs

- Please do not use a force of over 3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)



